

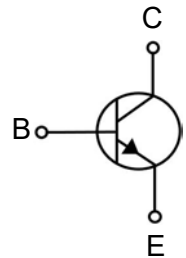
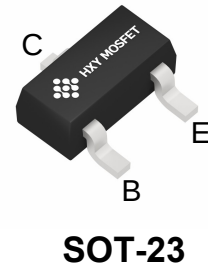


Features

- Collector Current: $I_C = 1A$
- Power Dissipation of 250mW

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
CMPT8099	SOT-23	493	3000



Maximum Ratings (Ta=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	120	V
V_{CEO}	Collector-Emitter Voltage	100	V
V_{EBO}	Emitter-Base Voltage	5	V
I_C	Collector Current	1	A
I_{CM}	Peak Pulse Current	2	A
P_C	Collector Power Dissipation	250	mW
$R_{\theta JA}$	Thermal Resistance From Junction To Ambient	500	°C/W
T_J, T_{stg}	Operation Junction And Storage Temperature Range	-55~+150	°C

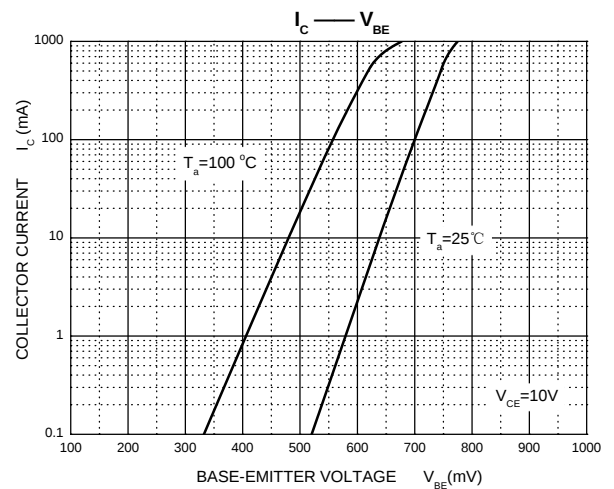
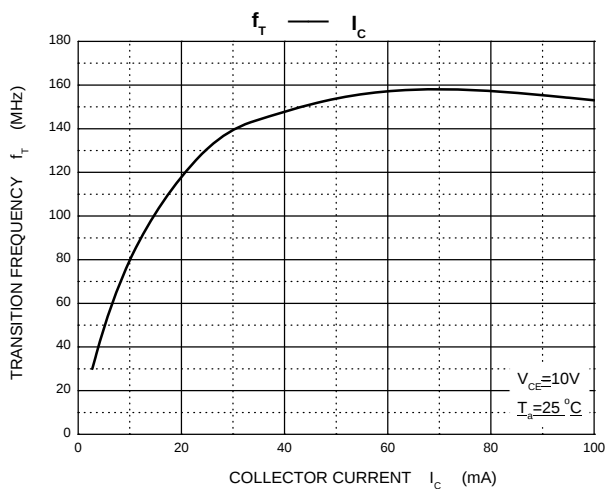
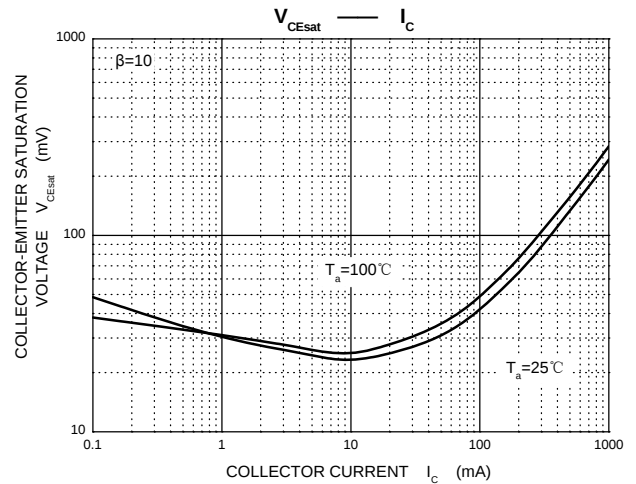
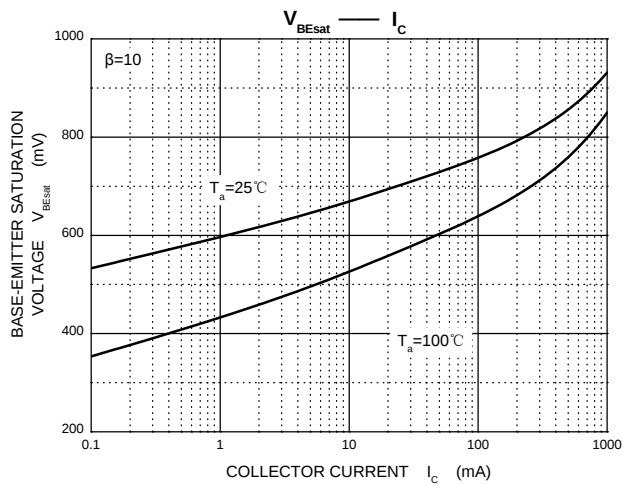
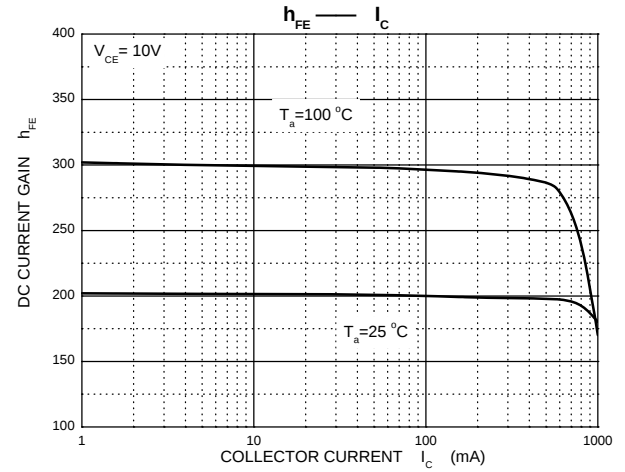
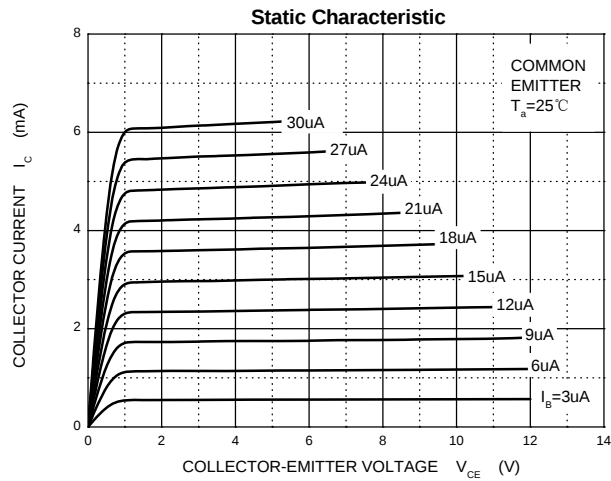
Electrical Characteristics (Ta=25°C unless otherwise noted)

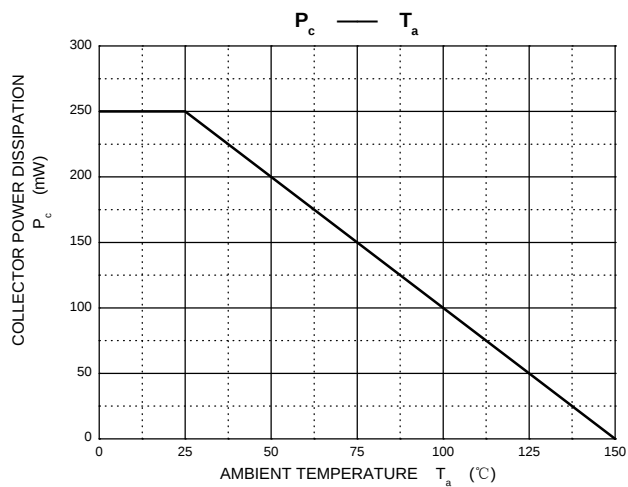
Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$V_{(BR)CBO}$	Collector-base breakdown voltage	$I_C = 100\mu A, I_E = 0$	120			V
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 10mA, I_B = 0$	100			V
$V_{(BR)EBO}$	Emitter-base breakdown voltage	$I_E = 100\mu A, I_C = 0$	5			V
I_{CBO}	Collector cut-off current	$V_{CB} = 100V, I_E = 0$			100	nA
I_{EBO}	Emitter cut-off current	$V_{EB} = 4V, I_C = 0$			100	nA
$h_{FE(1)}$	DC current gain(1)	$V_{CE} = 10V, I_C = 1mA$	100			
$h_{FE(2)}$	DC current gain(2)	$V_{CE} = 10V, I_C = 500mA$	100		300	
$h_{FE(3)}$	DC current gain(3)	$V_{CE} = 10V, I_C = 1A$	60			
$h_{FE(4)}$	DC current gain(4)	$V_{CE} = 10V, I_C = 2A$	20			
$V_{CE(sat)1}$	Collector-emitter saturation voltage	$I_C = 500mA, I_B = 50mA$			0.3	V
$V_{CE(sat)2}$	Collector-emitter saturation voltage	$I_C = 1A, I_B = 100mA$			0.6	V
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_C = 1A, I_B = 100mA$			1.15	V
V_{BE}	Base-emitter voltage	$V_{CE} = 5V, I_C = 1A$			1	V
f_T	Transition frequency	$V_{CE} = 10V, I_C = 50mA, f = 100MHz$	150			MHz
C_{ob}	Collector output capacitance	$V_{CB} = 10V, f = 1MHz$			10	pF

*Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2.0\%$.

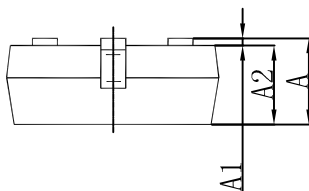
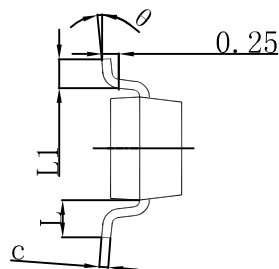
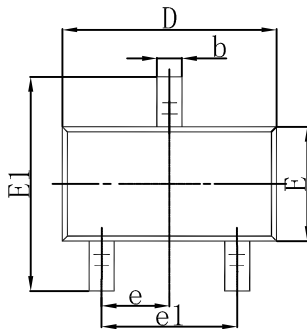


Typical Characteristics





SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°



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